

Power MOSFET

4A, 550V N-CHANNEL POWER MOSFET

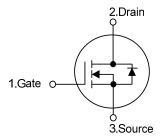
DESCRIPTION

The UTC **4N55-LC** is a high voltage power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

FEATURES

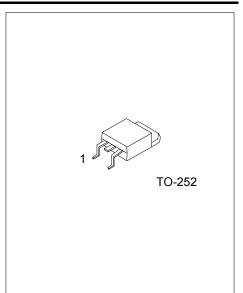
- * $R_{DS(ON)}$ < 2.5 Ω @ V_{GS} = 10V, I_D = 2.0A
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

SYMBOL



ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing	
Lead Free	Halogen Free	Package	1	2	3	Facking	
4N55L-TN3-R	4N55G-TN3-R	TO-252	G	D	S	Tape Reel	
Note: Pin Assignment: G: Gate D: Drain S: Source							
4N55G-TN3-R (1)Packing Type (1) R: Tape Reel (2)Package Type (2)Package Type (2) TN3: TO-252 (3)Green Package (3) G: Halogen Free and Lead Free, L: Lead Free						ad Free	
MARKING UTC 4N55 G: Halogen Free Date Code 1 Www.unisonic.com.tw Copyright @ 2018 Unicopying Co. Ltd							
www.unisonic.com.tw Copyright © 2018 Unisonic Technologies Co., Ltd QW-R					1 of 7 QW-R205-500.A		



■ **ABSOLUTE MAXIMUM RATINGS** (T_c = 25°C, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	V _{DSS}	550	V
Gate-Source Voltage	V _{GSS}	±30	V
Continuous Drain Current	ID	4	А
Pulsed Drain Current (Note 2)	I _{DM}	8	А
Avalanche Energy Single Pulsed (Note	3) E _{AS}	140	mJ
Peak Diode Recovery dv/dt (Note 4)	dv/dt	3	V/ns
Power Dissipation	PD	52	W
Junction Temperature	TJ	+150	°C
Storage Temperature	T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. L = 10mH, I_{AS} = 5.3A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C

4. $I_{SD} \le 4.0A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	110	°C/W	
Junction to Case	θ _{JC}	2.5 (Note)	°C/W	

Note: The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

■ ELECTRICAL CHARACTERISTICS (T_J = 25°C, unless otherwise specified)

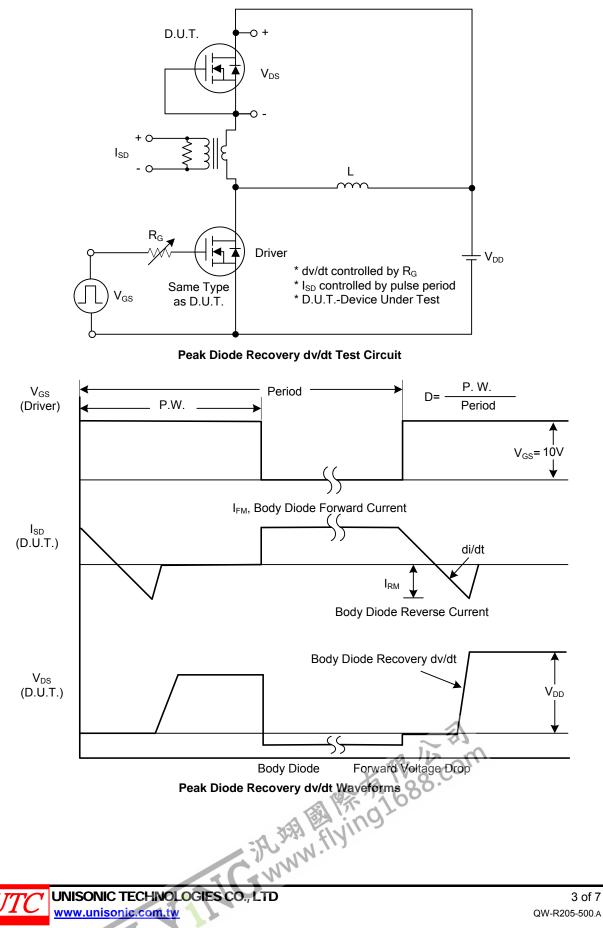
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} = 0V, I _D = 250µA	550			V
Drain-Source Leakage Current		I _{DSS}	$V_{DS} = 550V, V_{GS} = 0V$			10	μA
Gate- Source Leakage Current	Forward		$V_{GS} = 30V, V_{DS} = 0V$			100	nA
	Reverse	I _{GSS}	V_{GS} = -30V, V_{DS} = 0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} = V _{GS} , I _D = 250µA	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} = 10V, I _D = 2.0A			2.5	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance	nput Capacitance				363		pF
Output Capacitance		Coss	V _{DS} =25V, V _{GS} =0V, f=1.0 MHz		50		pF
Reverse Transfer Capacitance		C _{RSS}			6		pF
SWITCHING CHARACTERISTIC	S						
Total Gate Charge (Note 1)		Q_{G}			13		nC
Gate-Source Charge		Q_{GS}	V_{DS} =100V, V_{GS} =10V, I_{D} =4.0A,		5.4		nC
Gate-Drain Charge		Q_{GD}	I _D =1mA (Note 1, 2)		3		nC
Turn-On Delay Time (Note 1)		t _{D(ON)}			6.4		ns
Turn-On Rise Time		t _R	V _{DD} =100V, V _{GS} =10V, I _D =4.0A,		17		ns
Turn-Off Delay Time		t _{D(OFF)}	R _G =25Ω (Note 1, 2)		25.6		ns
Turn-Off Fall Time		t⊧			53.5		ns
DRAIN-SOURCE DIODE CHARA	CTERISTI	CS AND MA	XIMUM RATINGS	2			
Maximum Body-Diode Continuous Current		ls	KR (O			4	Α
Maximum Body-Diode Pulsed Current		I _{SM}	1 18 . 20.			8	Α
Drain-Source Diode Forward Voltage		V _{SD}	I _S =4.0A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time		trr			240		ns
Body Diode Reverse Recovery Charge		Qr	I_3 =4.0A , V _{GS} =0V di/dt=100A/µs		1.4		μC
Notes: 1. Pulse Test: Pulse width	< 300us D	A Real	20/A N				

Notes: 1. Pulse Test: Pulse width \leq 300µs, Duty cycle \leq 2%.

2. Essentially independent of operating temperature.

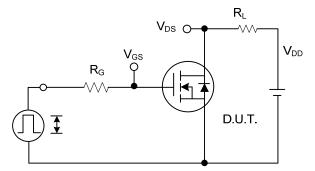
UNISONIC TECHNOLOGIES CO., LTD

TEST CIRCUITS AND WAVEFORMS

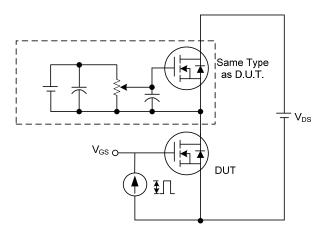


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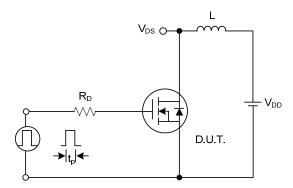
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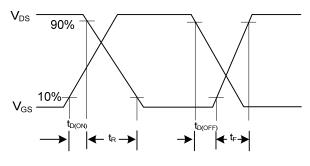
Switching Test Circuit



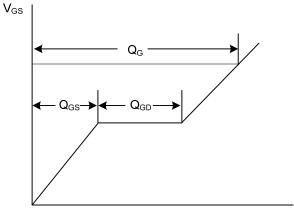
Gate Charge Test Circuit



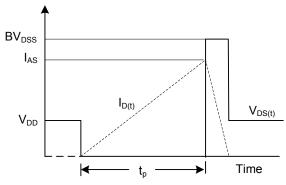
Unclamped Inductive Switching Test Circuit

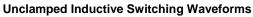


Switching Waveforms



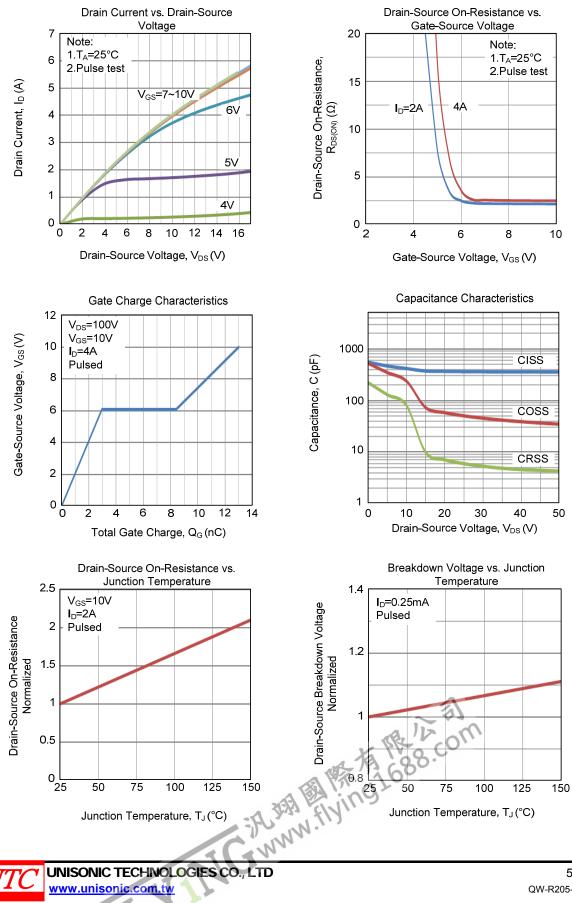
Charge Gate Charge Waveform



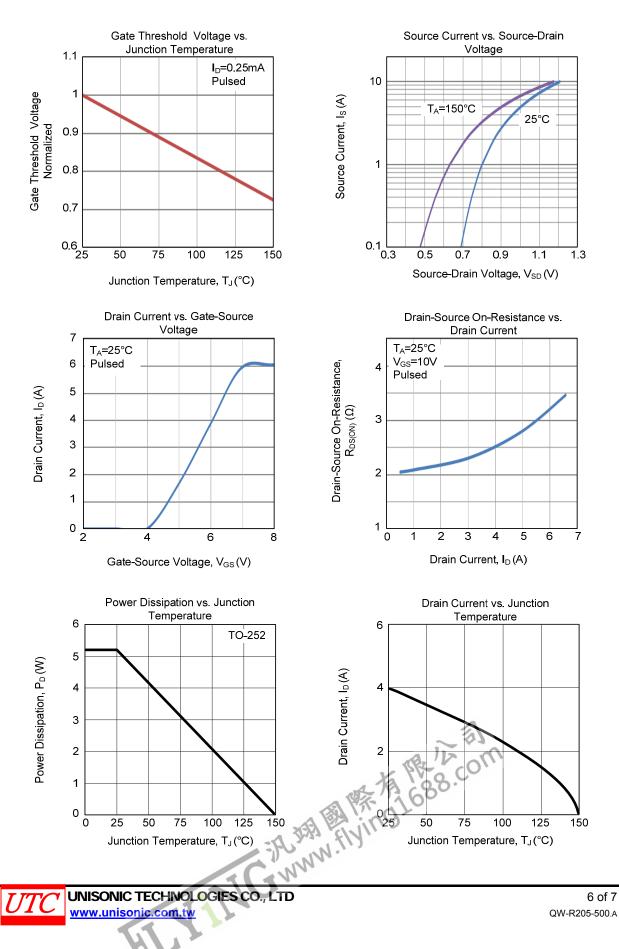




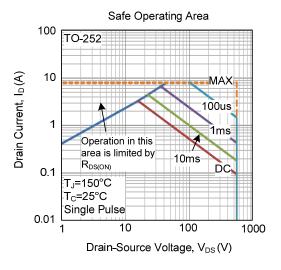
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)



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